imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Type 1DX

Order Number LBEE5KL1DX

2.4GHz Wi-Fi + Bluetooth 4.1 EDR Module Network Topology: AP & STA dual mode Chipset: Broadcom BCM4343W Processor: No Modulation: DSSS / CCK / OFDM

Description

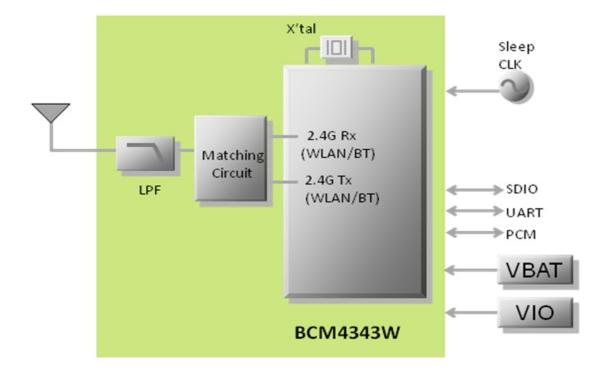
The Type 1DX module is an ultra-small module that includes 2.4GHz WLAN and Bluetooth functionality. Based on Broadcom BCM4343W, the module provide high-efficiency RF front end circuits. The module is designed to fit into small spaces and is smaller than a dime. Minimal external circuitry is required to complete a radio design; add an antenna, power source, clocks, processor, and associated interface hardware and the radio hardware design is complete. To ease Wi-Fi certification, the Type 1DX module complies with IEEE 802.11b/g/n and Bluetooth Version 4.1 plus EDR, Power Class 1 (10dBm max) + BLE. Software is available for Linux and Android.

Specs

Product Type Grade Frequency Frequency MHz (min) Frequency MHz (max) Chipset Processor Modulation Embedded Stack Antenna Sleep Clock System Clock **Operating Temperature Range** Operating Temperature °C (min) Operating Temperature °C (max) Mounting Type Package Dimension Supply Voltage (Vdc) Supply Voltage min Supply Voltage max Transmit Power Transmit Mode Current Receive Mode Current Data Rate WLAN Data Rate Bluetooth WLAN Bluetooth Power Class Technology Network Host Interface I/O Interface Host Interface Other Host Interface BT Interface Voltage (Vdc for VIO) FCC/IC Certified **ETSI** Certified **RoHs Compliant** ECCN ISO9001 TS16969

Module Consumer 2.4GHz 2400 2483.5 Broadcom BCM4343W No DSSS / CCK / OFDM No External Yes Internal X'tal -30 to +70C -30 70 SMT LGA 6.95 x 5.15 x 1.1 mm 3.6 3.35 for VBAT 4.2 for VBAT +17dBm / 11Mbps 370mA / 11Mbps 60mA 11, 54, 65 Mbps 3Mbps 802.11b/g/n v4.1+EDR Class 1 (10 dBm max) Wi-Fi + Bluetooth 4.1 EDR AP & STA dual mode SDIO PCM for BT audio No UART 1.8 or 3.3 No No Yes 5A992 No No

Block Diagram



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